

### Qualification Results Summary of LTM4632 with revised substrate

QUALIFICATION STATUS – LTM4632 BGA			
TEST	SPECIFICATION	SAMPLE SIZE	RESULTS
Temperature Cycle (TC)*	JEDEC <i>JESD22-A104</i>	<b>1*77</b>	<b>Pass</b>
Unbiased HAST (UHAST)*	JEDEC <i>JESD22-A102</i>	<b>1*77</b>	<b>Pass</b>
Thermal Shock (TS)*	JEDEC <i>JESD22-A106</i>	<b>1*77</b>	<b>Pass</b>
Solder Heat Resistance – MSL4 (SHR)*	JEDEC/IPC <i>J-STD-020</i>	<b>1*231</b>	<b>Pass</b>
Solder Heat Resistance – MSL3 (SHR)*	JEDEC/IPC <i>J-STD-020</i>	<b>1*110</b>	<b>Pass</b>

\*Preconditioned per JEDEC/IPC J-STD-020